

GB05SLT12-220

Silicon Carbide Power Schottky Diode

V_{RRM}	=	1200 V
V_{F}	=	1.6 V
I _F	=	5 A
\mathbf{Q}_{C}	=	35 nC

Features

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- · Temperature independent switching behavior
- · Superior surge current capability
- Positive temperature coefficient of V_F
- · Extremely fast switching speeds
- Superior figure of merit Q_C/I_F

Package

RoHS Compliant





TO - 220AC

Advantages

- Improved circuit efficiency (Lower overall cost)
- · Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- · Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- · Induction Heating
- Uninterruptible Power Supply (UPS)
- · High Voltage Multipliers

Maximum Ratings at T_j = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}		1200	V	
Continuous forward current	l _F	T _C ≤ 155 °C	5	Α	
RMS forward current	I _{F(RMS)}	T _C ≤ 155 °C	8	Α	
Surge non-repetitive forward current, Half Sine		$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	32	^	
Wave	I _{F,SM}	$T_C = 155 ^{\circ}\text{C}, t_P = 10 \text{ms}$	26	Α	
Non-repetitive peak forward current	$I_{F,max}$	T_C = 25 °C, t_P = 10 μ s	120	А	
l ² t value	∫i² dt	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	5	A ² s	
i t value		T_C = 155 °C, t_P = 10 ms	3.4		
Power dissipation	P _{tot}	T _C = 25 °C	117	W	
Operating and storage temperature	T_{j} , T_{stg}		-55 to 175	°C	

Electrical Characteristics at T_j = 175 °C, unless otherwise specified

Parameter	Cumbal	Conditions m		Values			1114
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	V _F	I _F = 5 A, T _j = 25 °C		1.6	1.9	V	
	VF	I _F = 5 A, T _j = 175 °C			2.6	3.0	V
Reverse current	1	V _R = 1200 V, T _j = 25 °C		5	50		
	I _R	V _R = 1200 V, T _j = 175 °C			10	100	μA
Total capacitive charge		V _R = 40			21		nC
	Q _C	$I_F \le I_{F,MAX}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	$V_{R} = 960 \text{ V}$		35		110
Switching time	+	T _i = 175 °C	V _R = 400 V		< 25		no
	ts	V _R = 960 V			\ 2 5		ns
Total capacitance		$V_R = 1 \text{ V, f} = 1 \text{ MHz, T}_j = 25 ^{\circ}\text{C}$		260			
	С	$V_R = 400 \text{ V}, f = 1 \text{ MHz}$	z, T _j = 25 °C		25		pF
		$V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_i = 25 ^{\circ}\text{C}$		20			

Thermal Characteristics

Thermal resistance, junction - case	R _{thJC}	1.4	°C/W
			_
Mechanical Properties			

Μ

Mounting torque

Nm

0.6



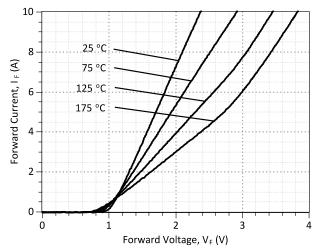


Figure 1: Typical Forward Characteristics

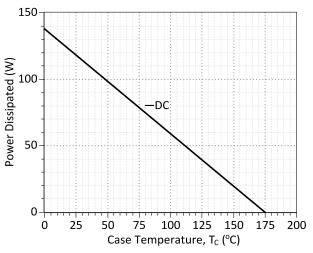


Figure 3: Power Derating Curve

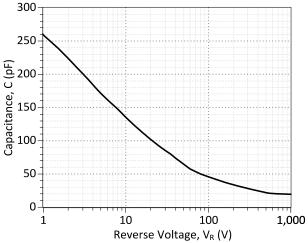


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

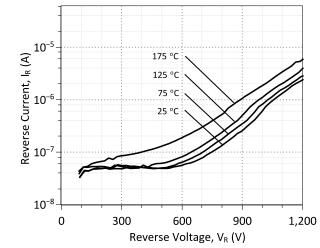


Figure 2: Typical Reverse Characteristics

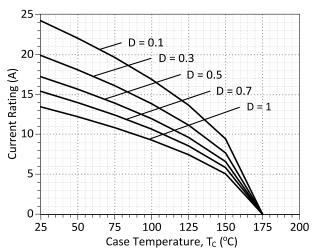


Figure 4: Current Derating Curves (D = t_P/T , t_P = 400 µs) (Considering worst case Z_{th} conditions)

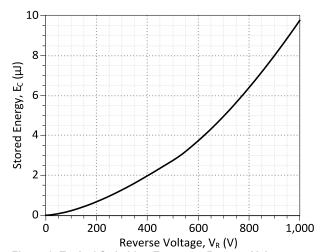


Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics



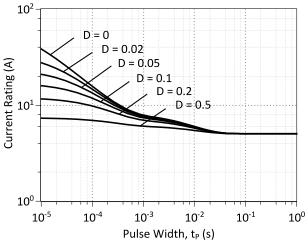


Figure 7: Current vs Pulse Duration Curves at T_C = 155 °C

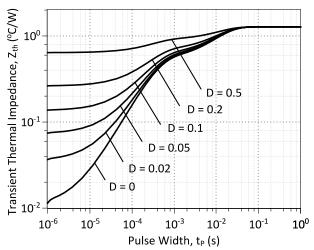
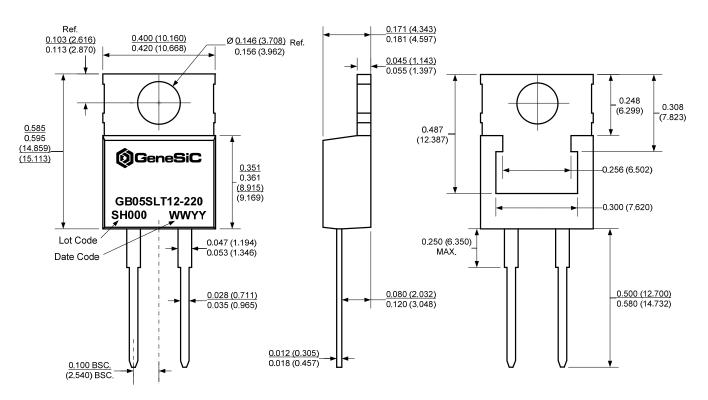


Figure 8: Transient Thermal Impedance

Package Dimensions:

TO-220AC

PACKAGE OUTLINE



NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments	Supersedes		
2013/11/12	3	Updated Electrical Characteristics			
2013/02/05	2	Second generation update			
2012/05/22	1	Second generation release			
2010/12/14	0	Initial release			

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GB05SLT12-220 device.

```
MODEL OF GeneSiC Semiconductor Inc.
    $Revision: 1.0
     $Date: 04-SEP-2013
    GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
    Dulles, VA 20166
    http://www.genesicsemi.com/index.php/sic-products/schottky
    COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
    ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB05SLT12-220 SPICE Model
.SUBCKT GB05SLT12 ANODE KATHODE
R1 ANODE INT R=((TEMP-24)*0.0015); Temperature Dependant Resistor
D1 INT KATHODE GB05SLT12 25C; Call the 25C Diode Model
D2 ANODE KATHODE GB05SLT12 PIN; Call the PiN Diode Model
.MODEL GB05SLT12 25C D
+ IS 5.83E-18
                                    0.1276
                          RS
+ N
         1
                         IKF
                                    602
         1.2
+ EG
                         XTI
+ CJO
                                    0.419
         3.00E-10
                        VJ
+ M
         1.6
                         FC
                                    0.5
+ TT
        1.00E-10
1.00E-03
                         BV
                                    1200
+ IBV
                         VPK
                                    1200
                                    SiC Schottky
+ IAVE
                          \mathtt{TYPE}
+ MFG GeneSiC Semiconductor
.MODEL GB05SLT12 PIN D
      3.50 E-12
                                   0.3648
+ IS
                        RS
+ N
         4.409
                                    73
                         IKF
+ EG
         3.23
                         XTI
                                    -6
+ FC
         0.5
                         TT
+ BV
         1200
                         IBV
                                    1.00E-03
+ VPK
         1200
                         IAVE
+ TYPE SiC_PiN
.ENDS
```

^{*} End of GB05SLT12-220 SPICE Model